

July 31, 2026

SAKATA INX CORP.

Notice Concerning Capital and Business Alliance
with CONNECTEC JAPAN Corporation

- Accelerating New Business Creation in the Semiconductor Materials Sector -

SAKATA INX CORPORATION (Head office: Chuo-ku, Osaka-shi; Representative Director, President & CEO: Yoshiaki Ueno; securities code: 4633; the "Company") announces that it has signed a capital and business alliance with CONNECTEC JAPAN Corporation ("CTJ"), which engages in contract-based assembly and packaging development of electronic devices, including semiconductors. This alliance is aimed at accelerating material development in new sectors that the Company is advancing, with a special focus on achieving a full-scale entry into the semiconductor materials sector.

[Overview]

Through the capital and business alliance with CTJ, the Company will combine its material development capabilities with CTJ's assembly and packaging, evaluation, and process development capabilities, integrating the processes from the development of semiconductor materials to their adoption in the market, aiming to shorten the lead time. Material development based on the dispersion technology that the Company has been developing will be combined with CTJ's technologies in assembly, packaging and evaluation, enabling prompt progress in market application, something that was hard to achieve with single materials.

At the same time, the Company's material development capabilities will permit CTJ to make proposals that are more appropriate for customer requests.

The two companies will strengthen the framework for future mass production, aiming to expand the business.

[Background of the alliance]

While the semiconductor back-end process market has been growing at an accelerating pace in recent years, it is vital to respond quickly to the market. For instance, the timing of adoption is limited for each product generation. The Company has been accumulating knowledge in material technologies through its research and development in the electronics and energy domain. However, strengthening evaluation, assembly and packaging, as well as customer contact, is essential if the Company's products are to be actually adopted in the market.

CTJ has a system in which evaluation, development, and manufacturing related to semiconductor assembly and packaging are integrated. Its strength lies in its ability to promptly implement a cycle of evaluation and improvement based on customer requests.

Through this alliance, the Company will acquire these functions and achieve integration of processes from material development to commercialization, with a focus on the semiconductor back-end process.

<Overview of CTJ>

Company name	CONNECTEC JAPAN Corporation
Location	3-1 Koudan-cho, Myoko-shi, Niigata Prefecture, 944-0020, Japan
Representative	Representative Director Chairman: Katsunori Hirata Representative Director President: Takahiro Nakano
Main businesses	Contract-based development, manufacturing, and evaluation services for overall electronic devices
Established	November 2009

CONNECTEC JAPAN

SAKATA INX...

Visual Communication Technology



(Right) SAKATA INX CORPORATION Representative Director, President & CEO Yoshiaki Ueno
(Center) CONNECTEC JAPAN Corporation Representative Director, Chairman Katsunori Hirata
(Left) CONNECTEC JAPAN Corporation Representative Director, President Takahiro Nakano

About SAKATA INX CORPORATION

Founded in 1896, SAKATA INX is the world's third largest chemical manufacturer in sales of printing inks, with operations in more than 20 countries and regions worldwide, including Asia, the Americas, and Europe. The company manufactures and sells printing inks used for various packages, beverage cans, and information media, industrial inkjet inks for digital printing, and image display materials for liquid crystal displays. Under the business theme of “Creation of Visual Communication Technology,” the company aims to “create an information culture that makes people's lives more comfortable” through environmentally-friendly and sustainable products and continues to take on the challenge of entering new fields. (<https://www.inx.co.jp/>)

About CONNECTEC JAPAN Corporation

CONNECTEC JAPAN Corporation is a provider of contract-based development, manufacturing, and evaluation services for overall electronic devices, including semiconductors. Excelling in high-flexibility contracting, its wide range of JISSO (Assembly and Packaging) technologies, its extensive experience and future potential, and its strong collaborative capabilities, the company provides contract-based development, manufacturing, and evaluation services across electronic devices that are closer to final products, including not only semiconductors but also modules, boards, and enclosures.

Contact

Corporate Communications Dept.

Corporate Relations Div.

E-Mail inx-prir@inx.co.jp